#### TOSHIBA PHOTOCOUPLER PHOTO RELAY

# **TLP179D**

# MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS BOARD TESTERS / SCANNERS

The TOSHIBA TLP179D Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP179D consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

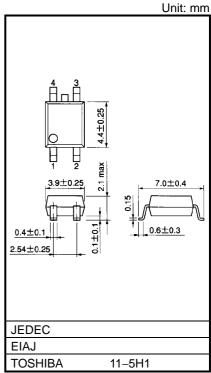
Its characteristics include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency mearsurement instruments.

#### **FEATURES**

• 4 pin SOP (2.54SOP4) : 2.1 mm high, 2.54 mm pitch

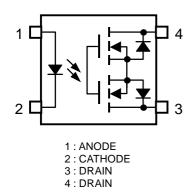
• 1-Form-A

Peak Off-State Voltage : 200 V (min)
 Trigger LED Current : 3 mA (max)
 On-State Current : 50 mA (max)
 On-State Resistance : 50 Ω (max)
 Output Capacitance : 20 pF (max)
 Isolation Voltage : 1500 Vrms (min)

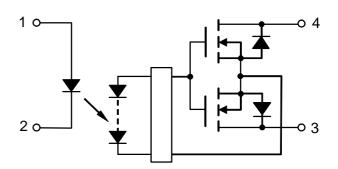


Weight: 0.1 g

#### **PIN CONFIGURATION (TOP VIEW)**



#### **SCHEMATIC**



### MAXIMUM RATINGS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	l <sub>F</sub>	50	mA
۵	Forward Current Derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
쁘	Reverse Voltage	$V_{R}$	5	V
	Junction Temperature	Tj	125	°C
~	Off-State Output Terminal Voltage	V <sub>OFF</sub>	200	V
DETECTOR	On-State Current	I <sub>ON</sub>	50	mA
	On-State Current Derating (Ta ≥ 25°C)	Δl <sub>ON</sub> /°C	-0.5	mA/°C
	Junction Temperature	Tj	125	°C
Storage Temperature Range		T <sub>stg</sub>	-55~125	°C
Operating Temperature Range		T <sub>opr</sub>	-40~85	°C
Lead Soldering Temperature (10 s)		T <sub>sol</sub>	260	°C
Isolat	tion Voltage (AC, 1 minute, R.H. $\leq$ 60%) (NOTE1)	BVS	1500	Vrms

(NOTE1): Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins shorted together.

#### **RECOMMENDED OPERATING CONDITIONS**

CHARACTERISTIC	SYMBOL	Min	Тур.	Max	UNIT
Supply Voltage	$V_{DD}$	_	_	160	V
Forward Current	l <sub>F</sub>	5	7.5	15	mA
On-State Current	I <sub>ON</sub>	_	_	50	mA
Operating Temperature	T <sub>opr</sub>	-20	_	60	°C

## INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = $25^{\circ}$ C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	Min	Тур.	Max	UNIT
	Forward Voltage	$V_{F}$	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μА
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MHz	_	30	_	pF
DETECTOR	Off-State Current	l <sub>OFF</sub>	V <sub>OFF</sub> = 160 V	_	_	1	nA
DETE	Capacitance	C <sub>OFF</sub>	V = 0, f = 1 MHz	_	15	20	pF

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#### **COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	Min	Тур.	Max	UNIT
Trigger LED Current	I <sub>FT</sub>	I <sub>ON</sub> = 50 mA	_	1	3	mA
Return LED Current	I <sub>FC</sub>	I <sub>OFF</sub> = 100 μA	0.1	_	_	mA
On-State Resistance	R <sub>ON</sub>	$I_{ON} = 50 \text{ mA}, I_F = 5 \text{ mA}$		40	50	Ω

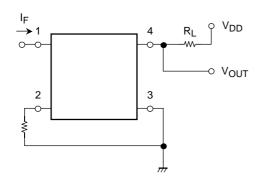
#### **ISOLATION CHARACTERISTICS (Ta = 25°C)**

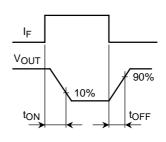
CHARACTERISTIC	SYMBOL	TEST CONDITION	Min	Тур.	Max	UNIT
Capacitance Input to Output	CS	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation Resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≦ 60%	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
		AC, 1 minute	1500	_	_	Vrms
Isolation Voltage	BVS	AC, 1 second (in oil)	_	3000	_	VIIIIS
		DC, 1 minute (in oil)	_	3000	_	Vdc

#### **SWITCHING CHARACTERISTICS (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	Min	Тур.	Max	UNIT
Turn-on Time	t <sub>ON</sub>	$R_L = 200 \Omega$ (NO	E 2) —	0.03	0.5	ms
Turn-off Time	tOFF	$V_{DD} = 10 \text{ V}, I_F = 5 \text{ mA}$	_	0.07	0.2	1115

(NOTE 2): SWITCHING TIME TEST CIRCUIT





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